

# DRAM

## MT4LC16M4A7, MT4LC16M4T8

For the latest data sheet, please refer to the Micron Web site: [www.micronsemi.com/mti/msp/html/datasheet.html](http://www.micronsemi.com/mti/msp/html/datasheet.html)

### FEATURES

- Single +3.3V  $\pm 0.3V$  power supply
- Industry-standard x4 pinout, timing, functions, and packages
- 13 row, 11 column addresses (A7)  
12 row, 12 column addresses (T8)
- High-performance CMOS silicon-gate process
- All inputs, outputs and clocks are LVTTTL-compatible
- FAST-PAGE-MODE (FPM) access
- 4,096-cycle CAS#-BEFORE-RAS# (CBR) REFRESH distributed across 64ms
- Optional self refresh (S) for low-power data retention

### OPTIONS

- Refresh Addressing  
4,096 (4K) rows  
8,192 (8K) rows
- Plastic Packages  
32-pin SOJ (400 mil)  
32-pin TSOP (400 mil)
- Timing  
50ns access  
60ns access
- Refresh Rates  
Standard Refresh  
Self Refresh (128ms period)

### MARKING

T8  
A7

DJ  
TG

None  
S\*

**NOTE:** 1. The 16 Meg x 4 FPM DRAM base number differentiates the offerings in one place—MT4LC16M4A7. The fifth field distinguishes various options: A7 designates an 8K refresh and T8 designates a 4K refresh for FPM DRAMs.  
2. The # symbol indicates signal is active LOW.

\*Contact factory for availability

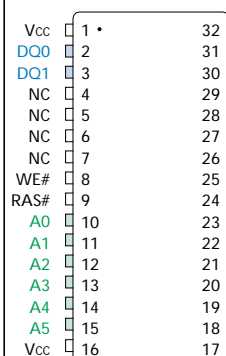
Part Number Example:  
**MT4LC16M4A7DJ**

### KEY TIMING PARAMETERS

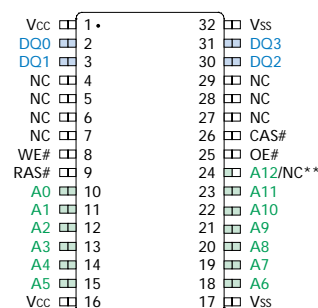
SPEED	t <sub>RC</sub>	t <sub>RAC</sub>	t <sub>PC</sub>	t <sub>AA</sub>	t <sub>CAC</sub>
-5	90ns	50ns	30ns	25ns	13ns
-6	110ns	60ns	35ns	30ns	15ns

### PIN ASSIGNMENT (Top View)

#### 32-Pin SOJ



#### 32-Pin TSOP



\*\*A12 on A7 version and NC on T8 version

### 16 MEG x 4 FPM DRAM PART NUMBERS

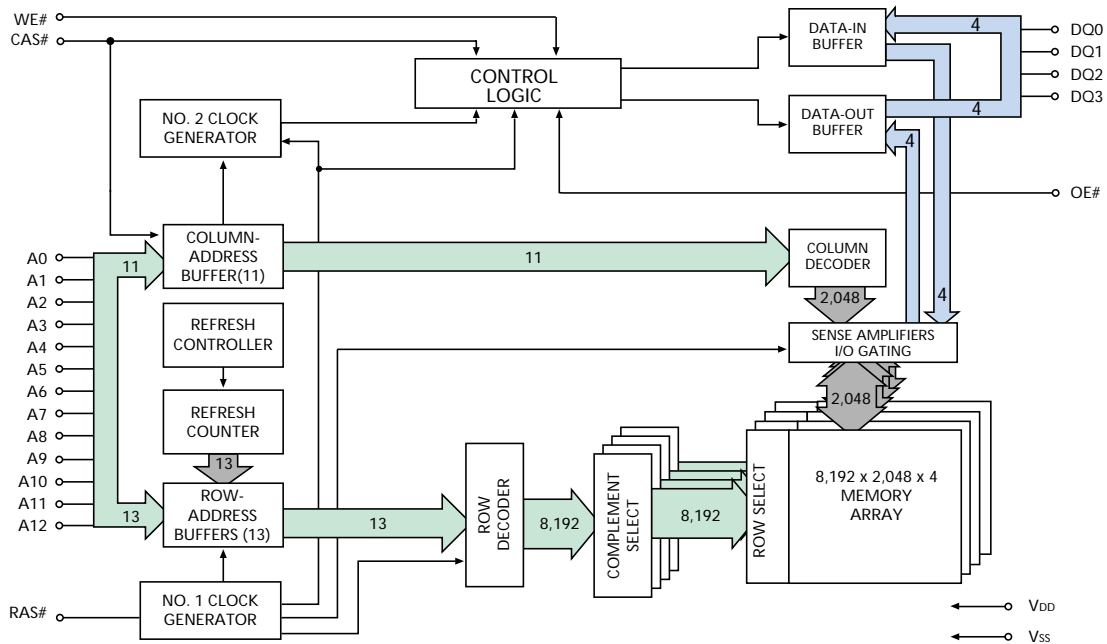
PART NUMBER	REFRESH ADDRESSING	PACKAGE	REFRESH
MT4LC16M4A7DJ-x	8K	SOJ	Standard
MT4LC16M4A7DJ-x S	8K	SOJ	Self
MT4LC16M4A7TG-x	8K	TSOP	Standard
MT4LC16M4A7TG-x S	8K	TSOP	Self
MT4LC16M4T8DJ-x	4K	SOJ	Standard
MT4LC16M4T8DJ-x S	4K	SOJ	Self
MT4LC16M4T8TG-x	4K	TSOP	Standard
MT4LC16M4T8TG-x S	4K	TSOP	Self

x = speed

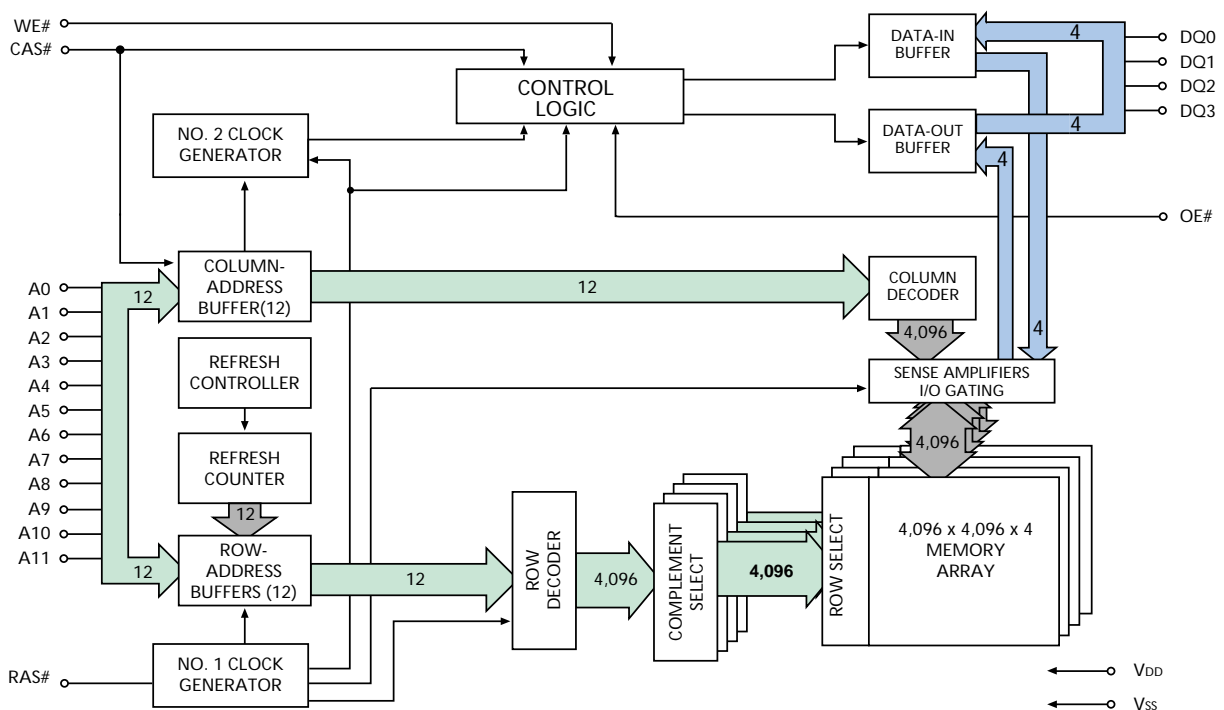
### GENERAL DESCRIPTION

The 16 Meg x 4 DRAMs are high-speed CMOS, dynamic random-access memory devices containing 67,108,864 bits organized in a x4 configuration. The MT4LC16M4A7 and MT4LC16M4T8 are functionally organized as 16,777,216 locations containing four bits each. The 16,777,216 memory locations are arranged in 8,192 rows by 2,048 columns for the MT4LC16M4A7 or 4,096 rows by 4,096 columns for the MT4LC16M4T8. During READ or WRITE cycles, each location is uniquely

## FUNCTIONAL BLOCK DIAGRAM MT4LC16M4A7 (13 row addresses)



## FUNCTIONAL BLOCK DIAGRAM MT4LC16M4T8 (12 row addresses)



## GENERAL DESCRIPTION (continued)

addressed via the address bits. First, the row address is latched by the RAS# signal, then the column address by CAS#. Both devices provide FAST-PAGE-MODE operation, allowing for fast successive data operations (READ, WRITE, or READ-MODIFY-WRITE) within a given row.

The MT4LC16M4A7 and MT4LC16M4T8 must be refreshed periodically in order to retain stored data.

## FAST PAGE MODE ACCESS

Each location in the DRAM is uniquely addressable as mentioned in the General Description. The data for each location is accessed via the four I/O pins (DQ0-DQ3). The WE# signal must be activated to execute a WRITE operation; otherwise, a READ operation will be performed. The OE# signal must be activated to enable the DQ output drivers for a read access and can be deactivated to disable output data if necessary.

FAST-PAGE-MODE operations are always initiated with a row address strobed in by the RAS# signal, followed by a column address strobed in by CAS#, just like for single location accesses. However, subsequent column locations within the row may then be accessed at the page mode cycle time. This is accomplished by cycling CAS# while holding RAS# LOW and entering new column addresses with each CAS# cycle. Returning RAS# HIGH terminates the FAST-PAGE-MODE operation.

## DRAM REFRESH

The supply voltage must be maintained at the specified levels, and the refresh requirements must be met in order to retain stored data in the DRAM. The refresh requirements are met by refreshing all 8,192 rows (A7) or all 4,096 rows (T8) in the DRAM array at least once every 64ms. The recommended procedure is to execute 4,096 CBR REFRESH cycles, either uniformly spaced or grouped in bursts, every 64ms. The MT4LC16M4A7 internally refreshes two rows for every CBR cycle,

whereas the MT4LC16M4T8 refreshes one row for every CBR cycle. So with either device, executing 4,096 CBR cycles covers all rows. The CBR refresh will invoke the internal refresh counter for automatic RAS# addressing. Alternatively, RAS#-ONLY REFRESH capability is inherently provided. However, with this method only one row is refreshed at a time; so for the MT4LC16M4A7, 8,192 RAS#-ONLY REFRESH cycles must be executed every 64ms to cover all rows. Some compatibility issues may become apparent. JEDEC strongly recommends the use of CBR REFRESH for this device.

An optional self refresh mode is also available on the "S" version. The self refresh feature is initiated by performing a CBR REFRESH cycle and holding RAS# LOW for the specified  $t_{RASS}$ . The "S" option allows for an extended refresh period of 128ms, or 31.25 $\mu$ s per row for a 4K refresh and 15.625 $\mu$ s per row for an 8K refresh, when using a distributed CBR REFRESH. This refresh rate can be applied during normal operation, as well as during a standby or battery backup mode.

The self refresh mode is terminated by driving RAS# HIGH for a minimum time of  $t_{RPS}$ . This delay allows for the completion of any internal refresh cycles that may be in process at the time of the RAS# LOW-to-HIGH transition. If the DRAM controller uses a distributed CBR refresh sequence, a burst refresh is not required upon exiting self refresh. However, if the DRAM controller utilizes RAS#-ONLY or burst CBR refresh sequence, all rows must be refreshed within the average internal refresh rate prior to the resumption of normal operation.

## STANDBY

Returning RAS# and CAS# HIGH terminates a memory cycle and decreases chip current to a reduced standby level. The chip is preconditioned for the next cycle during the RAS# HIGH time.

### ABSOLUTE MAXIMUM RATINGS\*

Voltage on V<sub>CC</sub> Relative to V<sub>SS</sub> ..... -1V to +4.6V

Voltage on NC, Inputs or I/O Pins

Relative to V<sub>SS</sub> ..... -1V to +4.6V

Operating Temperature, T<sub>A</sub> (ambient) ... 0°C to +70°C

Storage Temperature (plastic) ..... -55°C to +150°C

Power Dissipation ..... 1W

\*Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### DC ELECTRICAL CHARACTERISTICS AND OPERATING CONDITIONS

(Notes: 1, 5, 6) (V<sub>CC</sub> = +3.3V ±0.3V)

PARAMETER/CONDITION	SYMBOL	MIN	MAX	UNITS	NOTES
SUPPLY VOLTAGE	V <sub>CC</sub>	3	3.6	V	
INPUT HIGH VOLTAGE: Valid Logic 1; All inputs, I/Os and any NC	V <sub>IH</sub>	2	V <sub>CC</sub> + 0.3	V	26
INPUT LOW VOLTAGE: Valid Logic 0; All inputs, I/Os and any NC	V <sub>IL</sub>	-0.3	0.8	V	26
INPUT LEAKAGE CURRENT: Any input at V <sub>IN</sub> (0V ≤ V <sub>IN</sub> ≤ V <sub>CC</sub> + 0.3V); All other pins not under test = 0V	I <sub>I</sub>	-2	2	μA	
OUTPUT HIGH VOLTAGE: I <sub>OUT</sub> = -2mA	V <sub>OH</sub>	2.4	–	V	
OUTPUT LOW VOLTAGE: I <sub>OUT</sub> = 2mA	V <sub>OL</sub>	–	0.4	V	
OUTPUT LEAKAGE CURRENT: Any output at V <sub>OUT</sub> (0V ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub> + 0.3V); DQ is disabled and in High-Z state	I <sub>OZ</sub>	-5	5	μA	

## I<sub>CC</sub> OPERATING CONDITIONS AND MAXIMUM LIMITS

(Notes: 1, 2, 3, 5, 6) ( $V_{CC} = +3.3V \pm 0.3V$ )

PARAMETER/CONDITION	SYMBOL	SPEED	4K REFRESH	8K REFRESH	UNITS	NOTES
STANDBY CURRENT: TTL (RAS# = CAS# = $V_{IH}$ )	I <sub>CC1</sub>	ALL	1	1	mA	
STANDBY CURRENT: CMOS (RAS# = CAS# $\geq V_{CC} - 0.2V$ , DQs may be left open, other inputs: $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$ )	I <sub>CC2</sub>	ALL	500	500	$\mu A$	
OPERATING CURRENT: Random READ/WRITE Average power supply current (RAS#, CAS#, address cycling: $t_{RC} = t_{RC} [MIN]$ )	I <sub>CC3</sub>	-5 -6	170 160	130 120	mA	25
OPERATING CURRENT: FAST PAGE MODE Average power supply current (RAS# = $V_{IL}$ , CAS#, address cycling: $t_{PC} = t_{PC} [MIN]$ )	I <sub>CC4</sub>	-5 -6	100 90	100 90	mA	25
REFRESH CURRENT: RAS#-ONLY Average power supply current (RAS# cycling, CAS# = $V_{IH}$ ; $t_{RC} = t_{RC} [MIN]$ )	I <sub>CC5</sub>	-5 -6	170 160	130 120	mA	22
REFRESH CURRENT: CBR Average power supply current (RAS#, CAS#, address cycling: $t_{RC} = t_{RC} [MIN]$ )	I <sub>CC6</sub>	-5 -6	170 160	130 120	mA	4, 7
REFRESH CURRENT: Extended ("S" version only) Average power supply current: CAS# = 0.2V or CBR cycling; RAS# = $t_{RAS} (MIN)$ ; WE# = $V_{CC} - 0.2V$ ; A0-A11, OE# and $D_{IN} = V_{CC} - 0.2V$ or 0.2V ( $D_{IN}$ may be left open)	I <sub>CC7</sub>	ALL	400	400	$\mu A$	4, 7
REFRESH CURRENT: Self ("S" version only) Average power supply current: CBR with RAS# $\geq t_{RASS} (MIN)$ and CAS# held LOW; WE# = $V_{CC} - 0.2V$ ; A0-A11, OE# and $D_{IN} =$ $V_{CC} - 0.2V$ or 0.2V ( $D_{IN}$ may be left open)	I <sub>CC8</sub>	ALL	400	400	$\mu A$	4, 7

## CAPACITANCE

(Note: 2)

PARAMETER	SYMBOL	MAX	UNITS
Input Capacitance: Address pins	C <sub>I1</sub>	5	pF
Input Capacitance: RAS#, CAS#, WE#, OE#	C <sub>I2</sub>	7	pF
Input/Output Capacitance: DQ	C <sub>IO</sub>	7	pF

## AC ELECTRICAL CHARACTERISTICS

(Notes: 5, 6, 7, 8, 9, 10, 11, 12) (V<sub>CC</sub> = +3.3V ±0.3V)

AC CHARACTERISTICS		-5		-6		UNITS	NOTES
PARAMETER	SYMBOL	MIN	MAX	MIN	MAX		
Access time from column address	t <sub>AA</sub>		25		30	ns	
Column-address hold time (referenced to RAS#)	t <sub>AR</sub>	40		45		ns	
Column-address setup time	t <sub>ASC</sub>	0		0		ns	
Row-address setup time	t <sub>ASR</sub>	0		0		ns	
Column address to WE# delay time	t <sub>AWD</sub>	48		55		ns	18
Access time from CAS#	t <sub>CAC</sub>		13		15	ns	
Column-address hold time	t <sub>CAH</sub>	8		10		ns	
CAS# pulse width	t <sub>CAS</sub>	13	10,000	15	10,000	ns	
CAS# LOW to "Don't Care" during Self Refresh	t <sub>CHD</sub>	15		15		ns	
CAS# hold time (CBR Refresh)	t <sub>CHR</sub>	15		15		ns	4
CAS# to output in Low-Z	t <sub>CLZ</sub>	3		3		ns	
CAS# precharge time (FAST PAGE MODE)	t <sub>CP</sub>	8		10		ns	13
Access time from CAS# precharge	t <sub>CPA</sub>		30		35	ns	
CAS# to RAS# precharge time	t <sub>CRP</sub>	5		5		ns	
CAS# hold time	t <sub>CSH</sub>	50		60		ns	
CAS# setup time (CBR Refresh)	t <sub>CSR</sub>	5		5		ns	4
CAS# to WE# delay time	t <sub>CWD</sub>	36		40		ns	18
WRITE command to CAS# lead time	t <sub>CWL</sub>	13		15		ns	
Data-in hold time	t <sub>DH</sub>	8		10		ns	19
Data-in setup time	t <sub>DS</sub>	0		0		ns	19
Output disable	t <sub>OD</sub>	3	13	3	15	ns	23, 24
Output enable time	t <sub>OE</sub>		13		15	ns	20
OE# hold time from WE# during READ-MODIFY-WRITE cycle	t <sub>OEH</sub>	13		15		ns	24
Output buffer turn-off delay	t <sub>OFF</sub>	3	13	3	15	ns	17, 23
OE# setup prior to RAS# during HIDDEN REFRESH cycle	t <sub>ORD</sub>	0		0		ns	
FAST-PAGE-MODE READ or WRITE cycle time	t <sub>PC</sub>	30		35		ns	
FAST-PAGE-MODE READ-WRITE cycle time	t <sub>PRWC</sub>	76		85		ns	
Access time from RAS#	t <sub>RAC</sub>		50		60	ns	
RAS# to column-address delay time	t <sub>RAD</sub>	13		15		ns	15

## AC ELECTRICAL CHARACTERISTICS

(Notes: 5, 6, 7, 8, 9, 10, 11, 12) ( $V_{CC} = +3.3V \pm 0.3V$ )

AC CHARACTERISTICS		-5		-6		UNITS	NOTES
PARAMETER	SYMBOL	MIN	MAX	MIN	MAX		
Row-address hold time	$t_{RAH}$	8		10		ns	
RAS# pulse width	$t_{RAS}$	50	10,000	60	10,000	ns	
RAS# pulse width (FAST PAGE MODE)	$t_{RASP}$	50	125,000	60	125,000	ns	23
RAS# pulse width during Self Refresh	$t_{RASS}$	100		100		$\mu s$	
Random READ or WRITE cycle time	$t_{RC}$	90		110		ns	
RAS# to CAS# delay time	$t_{RCD}$	18		20		ns	14
READ command hold time (referenced to CAS#)	$t_{RCH}$	0		0		ns	16
READ command setup time	$t_{RCS}$	0		0		ns	
Refresh period	$t_{REF}$		64		64	ms	22
Refresh period (4,096 cycles) "S" version	$t_{REF}$		128		128	ms	4
RAS# precharge time	$t_{RP}$	30		40		ns	
RAS# to CAS# precharge time	$t_{RPC}$	0		0		ns	
RAS# precharge time exiting Self Refresh	$t_{RPS}$	90		105		ns	
READ command hold time (referenced to RAS#)	$t_{RRH}$	0		0		ns	16
RAS# hold time	$t_{RSH}$	13		15		ns	
READ-WRITE cycle time	$t_{RWC}$	131		155		ns	
RAS# to WE# delay time	$t_{RWD}$	73		85		ns	18
WRITE command to RAS# lead time	$t_{RWL}$	13		15		ns	
Transition time (rise or fall)	$t_T$	2	50	2	50	ns	
WRITE command hold time	$t_{WCH}$	8		10		ns	
WRITE command hold time (referenced to RAS#)	$t_{WCR}$	40		45		ns	
WE# command setup time	$t_{WCS}$	0		0		ns	18
WRITE command pulse width	$t_{WP}$	8		10		ns	
WE# hold time (CBR Refresh)	$t_{WRH}$	10		10		ns	4, 23
WE# setup time (CBR Refresh)	$t_{WRP}$	10		10		ns	4, 23

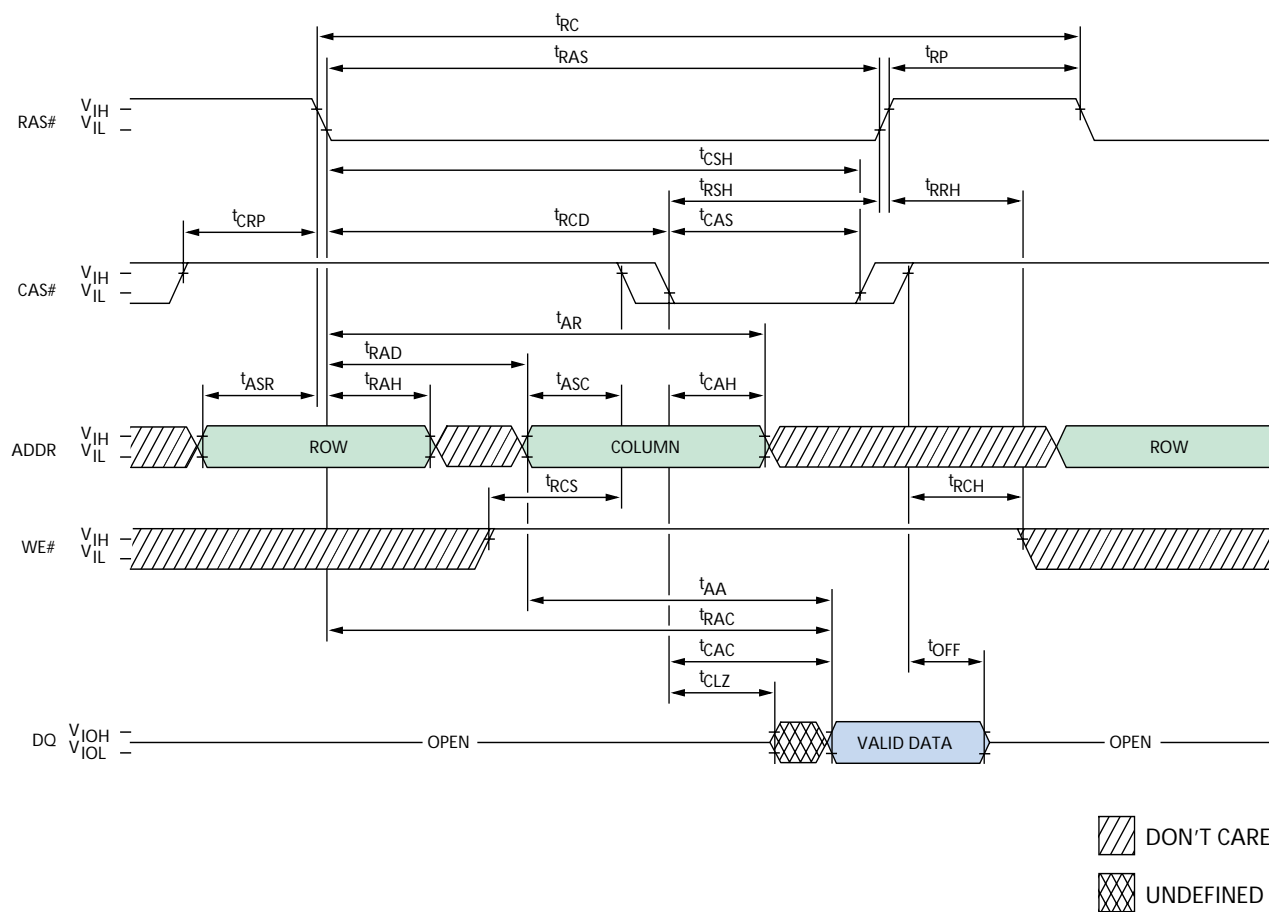


## NOTES

1. All voltages referenced to Vss.
2. This parameter is sampled. VCC = +3.3V; f = 1 MHz.
3. Icc is dependent on output loading and cycle rates. Specified values are obtained with minimum cycle time and the outputs open.
4. Enables on-chip refresh and address counters.
5. The minimum specifications are used only to indicate cycle time at which proper operation over the full temperature range is ensured.
6. An initial pause of 100μs is required after power-up, followed by eight RAS# refresh cycles (RAS#-ONLY or CBR with WE# HIGH), before proper device operation is ensured. The eight RAS# cycle wake-ups should be repeated any time the tREF refresh requirement is exceeded.
7. AC characteristics assume T = 5ns.
8. VIH (MIN) and VIL (MAX) are reference levels for measuring timing of input signals. Transition times are measured between VIH and VIL (or between VIL and VIH).
9. In addition to meeting the transition rate specification, all input signals must transit between VIH and VIL (or between VIL and VIH) in a monotonic manner.
10. If CAS# = VIH, data output is High-Z.
11. If CAS# = VIL, data output may contain data from the last valid READ cycle.
12. Measured with a load equivalent to two TTL gates, 100pF and VOL = 0.8V and VOH = 2V.
13. If CAS# is LOW at the falling edge of RAS#, output data will be maintained from the previous cycle. To initiate a new cycle and clear the data-out buffer, CAS# must be pulsed HIGH for tCP.
14. The tRCD (MAX) limit is no longer specified. tRCD (MAX) was specified as a reference point only. If tRCD was greater than the specified tRCD (MAX) limit, then access time was controlled exclusively by tCAC (tRAC [MIN] no longer applied). With or without the tRCD limit, tAA and tCAC must always be met.
15. The tRAD (MAX) limit is no longer specified. tRAD (MAX) was specified as a reference point only. If tRAD was greater than the specified tRAD (MAX) limit, then access time was controlled exclusively by tAA (tRAC and tCAC no longer applied). With or without the tRAD (MAX) limit, tAA, tRAC, and tCAC must always be met.
16. Either tRCH or tRRH must be satisfied for a READ cycle.
17. tOFF (MAX) defines the time at which the output achieves the open circuit condition and is not referenced to VOH or VOL.
18. tWCS, tRWD, tAWD, and tCWD are not restrictive operating parameters. tWCS applies to EARLY WRITE cycles. If tWCS > tWCS (MIN), the cycle is an EARLY WRITE cycle and the data output will remain an open circuit throughout the entire cycle. tRWD, tAWD, and tCWD define READ-MODIFY-WRITE cycles. Meeting these limits allows for reading and disabling output data and then applying input data. The values shown were calculated for reference allowing 10ns for the external latching of read data and application of write data. OE# held HIGH and WE# taken LOW after CAS# goes LOW result in a LATE WRITE (OE#-controlled) cycle. tWCS, tRWD, tCWD and tAWD are not applicable in a LATE WRITE cycle.
19. These parameters are referenced to CAS# leading edge in EARLY WRITE cycles and WE# leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
20. If OE# is tied permanently LOW, LATE WRITE or READ-MODIFY-WRITE operations are not possible.
21. A HIDDEN REFRESH may also be performed after a WRITE cycle. In this case, WE# = LOW and OE# = HIGH.
22. RAS#-ONLY REFRESH requires that all 8,192 rows of the MT4LC16M4A7 or all 4,096 rows of the MT4LC16M4T8 be refreshed at least once every 64ms. CBR REFRESH for either device requires that at least 4,096 cycles be completed every 64ms.
23. The DQs open during READ cycles once tOD or tOFF occur. If CAS# goes HIGH before OE#, the DQs will open regardless of the state of OE#. If CAS# stays LOW while OE# is brought HIGH, the DQs will open. If OE# is brought back LOW (CAS# still LOW), the DQs will provide the previously read data.
24. LATE WRITE and READ-MODIFY-WRITE cycles must have both tOD and tOE# met (OE# HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. If OE# is taken back LOW while CAS# remains LOW, the DQs will remain open.
25. Column address changed once each cycle.
26. VIH overshoot: VIH (MAX) = VCC + 2V for a pulse width ≤ 10ns, and the pulse width cannot be greater than one third of the cycle rate. VIL undershoot: VIL (MIN) = -2V for a pulse width ≤ 10ns, and the pulse width cannot be greater than one third of the cycle rate.



## READ CYCLE

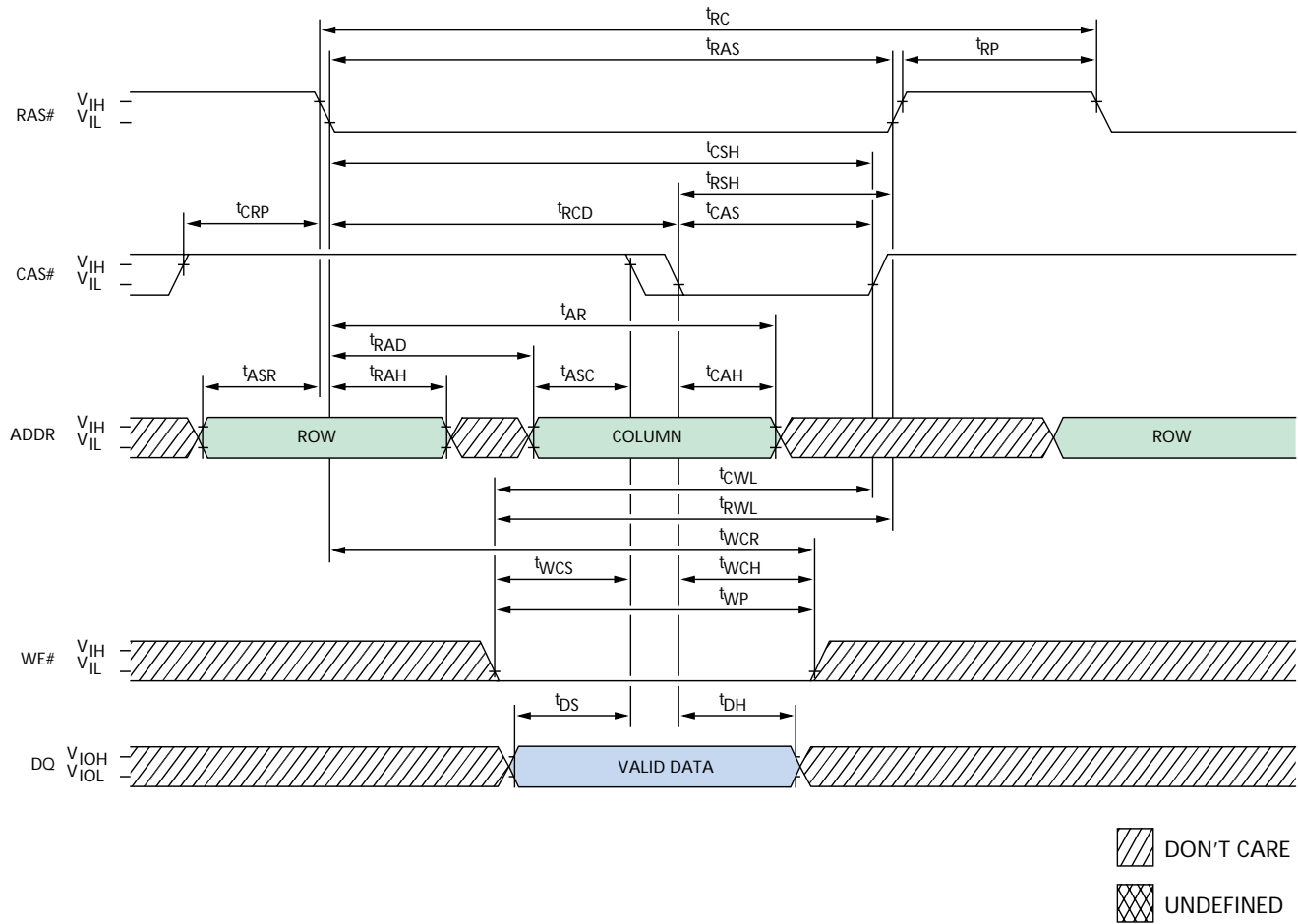


## TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>AA</sub>		25		30	ns
t <sub>AR</sub>	40		45		ns
t <sub>ASC</sub>	0		0		ns
t <sub>ASR</sub>	0		0		ns
t <sub>CAC</sub>		13		15	ns
t <sub>CAH</sub>	8		10		ns
t <sub>CAS</sub>	13	10,000	15	10,000	ns
t <sub>CLZ</sub>	3		3		ns
t <sub>CRP</sub>	5		5		ns
t <sub>CSH</sub>	50		60		ns
t <sub>OD</sub>	3	13	3	15	ns
t <sub>OE</sub>		13		15	ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>OFF</sub>	3	13	3	15	ns
t <sub>RAC</sub>		50		60	ns
t <sub>RAD</sub>	13		15		ns
t <sub>RAH</sub>	8		10		ns
t <sub>RAS</sub>	50	10,000	60	10,000	ns
t <sub>RC</sub>	90		110		ns
t <sub>RCD</sub>	18		20		ns
t <sub>RCH</sub>	0		0		ns
t <sub>RCS</sub>	0		0		ns
t <sub>RP</sub>	30		40		ns
t <sub>RRH</sub>	0		0		ns
t <sub>RSH</sub>	13		15		ns

## EARLY WRITE CYCLE

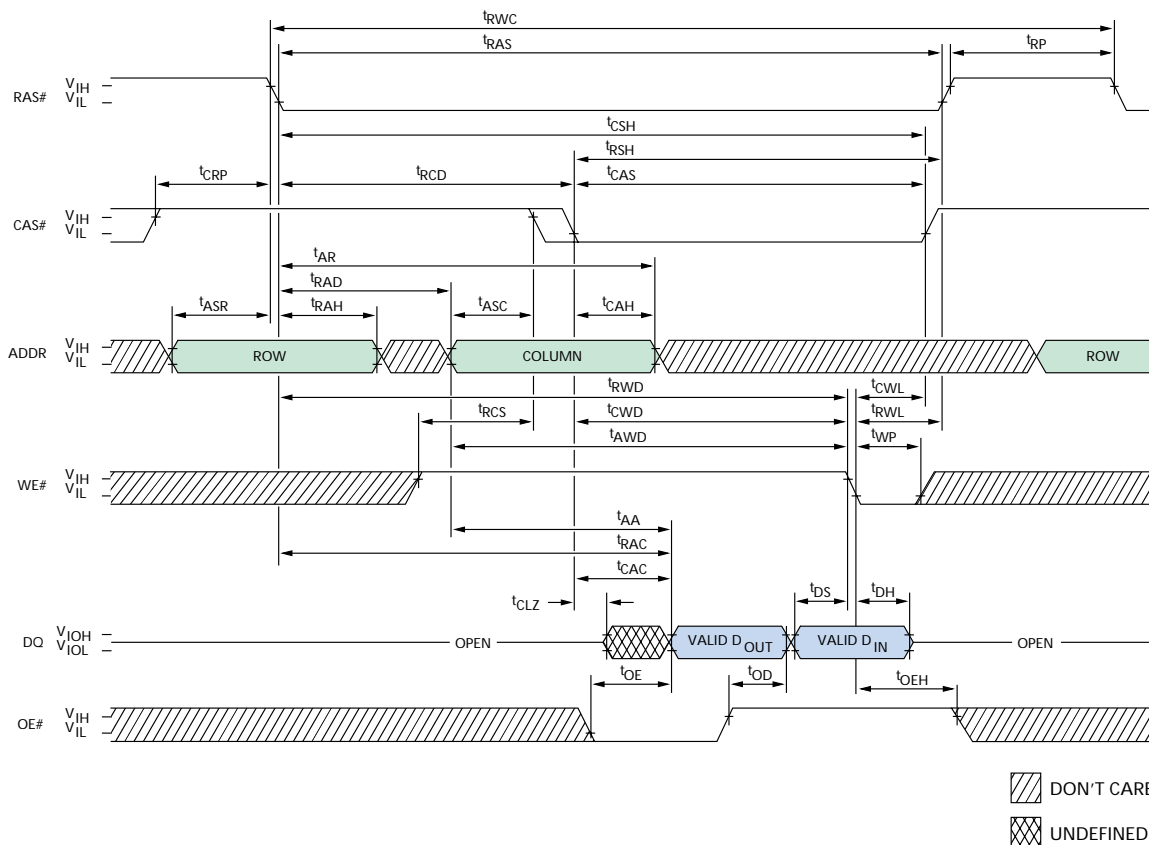


## TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{AR}$	40		45		ns
$t_{ASC}$	0		0		ns
$t_{ASR}$	0		0		ns
$t_{CAH}$	8		10		ns
$t_{CAS}$	13	10,000	15	10,000	ns
$t_{CRP}$	5		5		ns
$t_{CSH}$	50		60		ns
$t_{CWL}$	13		15		ns
$t_{DH}$	8		10		ns
$t_{DS}$	0		0		ns
$t_{RAD}$	13		15		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{RAH}$	8		10		ns
$t_{RAS}$	50	10,000	60	10,000	ns
$t_{RC}$	90		110		ns
$t_{RCD}$	18		20		ns
$t_{RP}$	30		40		ns
$t_{RSH}$	13		15		ns
$t_{RWL}$	13		15		ns
$t_{WCH}$	8		10		ns
$t_{WCR}$	40		45		ns
$t_{WCS}$	0		0		ns
$t_{WVP}$	8		10		ns

## READ-WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE cycles)

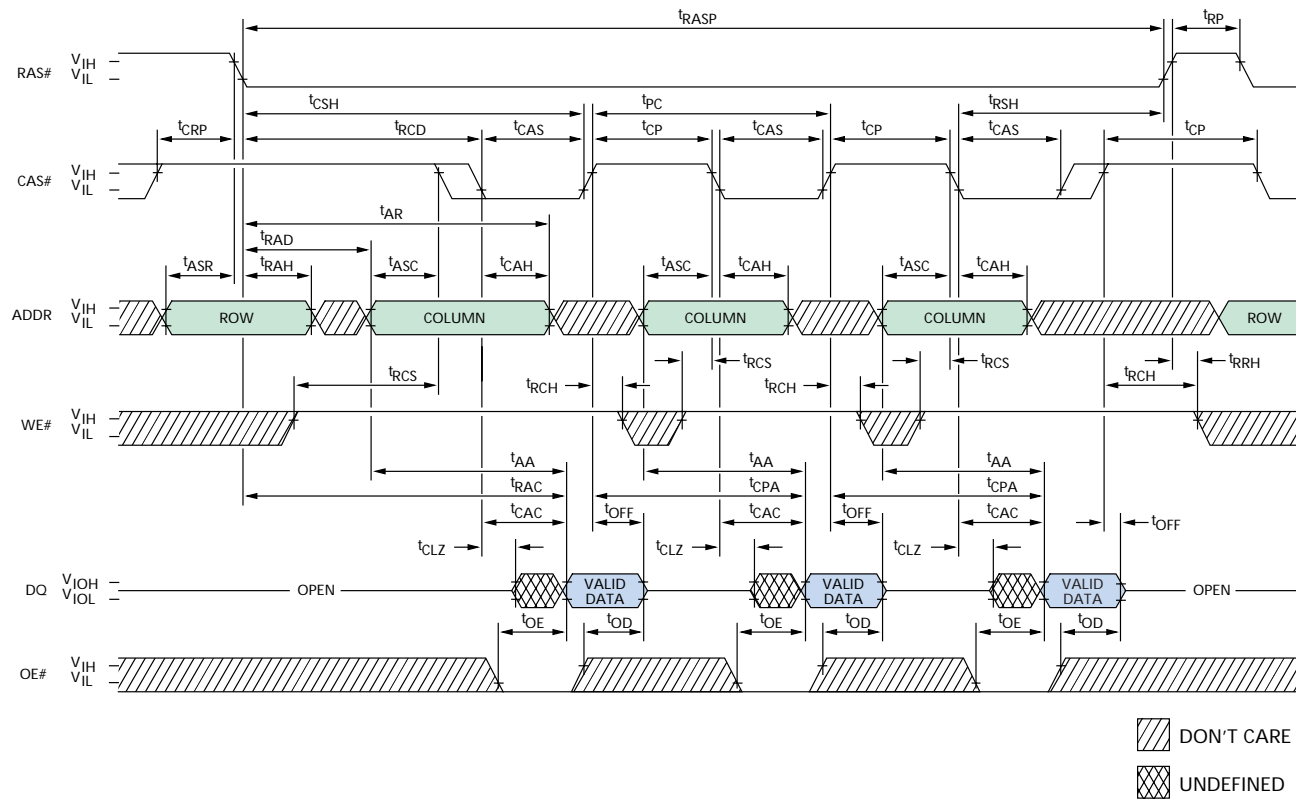


### TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{AA}$		25		30	ns
$t_{AR}$	40		45		ns
$t_{ASC}$	0		0		ns
$t_{ASR}$	0		0		ns
$t_{AWD}$	48		55		ns
$t_{CAC}$		13		15	ns
$t_{CAH}$	8		10		ns
$t_{CAS}$	13	10,000	15	10,000	ns
$t_{CLZ}$	3		3		ns
$t_{CRP}$	5		5		ns
$t_{CSH}$	50		60		ns
$t_{CWD}$	36		40		ns
$t_{CWL}$	13		15		ns
$t_{DH}$	8		10		ns
$t_{DS}$	0		0		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{OD}$	3	13	3	15	ns
$t_{OE}$		13		15	ns
$t_{OEH}$	13		15		ns
$t_{RAC}$		50		60	ns
$t_{RAD}$	13		15		ns
$t_{RAH}$	8		10		ns
$t_{RAS}$	50	10,000	60	10,000	ns
$t_{RCD}$	18		20		ns
$t_{RCS}$	0		0		ns
$t_{RP}$	30		40		ns
$t_{RSH}$	13		15		ns
$t_{RWC}$	131		155		ns
$t_{RWD}$	73		85		ns
$t_{RWL}$	13		15		ns
$t_{WP}$	8		10		ns

## FAST-PAGE-MODE READ CYCLE

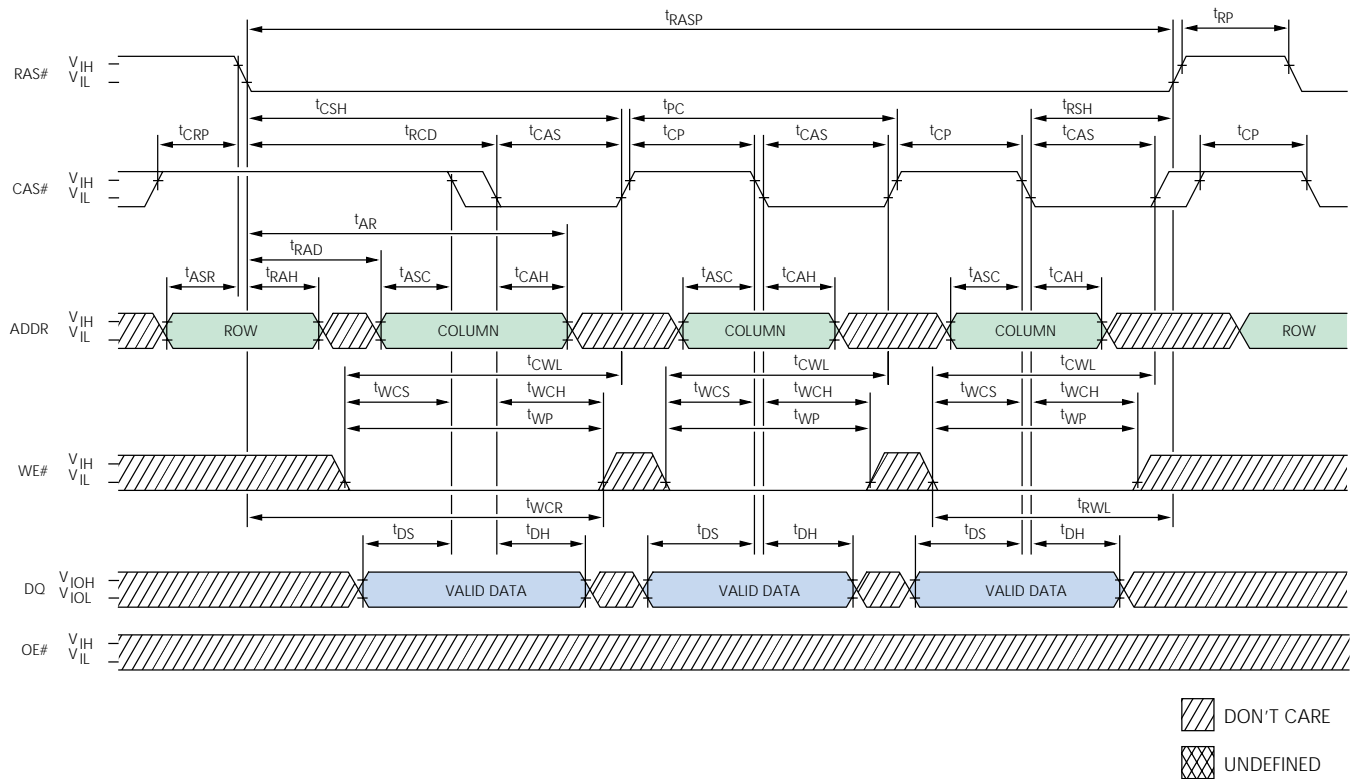


## TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>AA</sub>		25		30	ns
t <sub>AR</sub>	40		45		ns
t <sub>ASC</sub>	0		0		ns
t <sub>ASR</sub>	0		0		ns
t <sub>CAC</sub>		13		15	ns
t <sub>CAH</sub>	8		10		ns
t <sub>CAS</sub>	13	10,000	15	10,000	ns
t <sub>CLZ</sub>	3		3		ns
t <sub>CP</sub>	8		10		ns
t <sub>CPA</sub>		30		35	ns
t <sub>CRP</sub>	5		5		ns
t <sub>CSH</sub>	50		60		ns
t <sub>OD</sub>	3	13	3	15	ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>OE</sub>		13		15	ns
t <sub>OFF</sub>	3	13	3	15	ns
t <sub>PC</sub>	30		35		ns
t <sub>RAC</sub>		50		60	ns
t <sub>RAD</sub>	13		15		ns
t <sub>RAH</sub>	8		10		ns
t <sub>RASP</sub>	50	125,000	60	125,000	ns
t <sub>RCD</sub>	18		20		ns
t <sub>RCH</sub>	0		0		ns
t <sub>RCS</sub>	0		0		ns
t <sub>RP</sub>	30		40		ns
t <sub>RRH</sub>	0		0		ns
t <sub>RSH</sub>	13		15		ns

## FAST-PAGE-MODE EARLY WRITE CYCLE

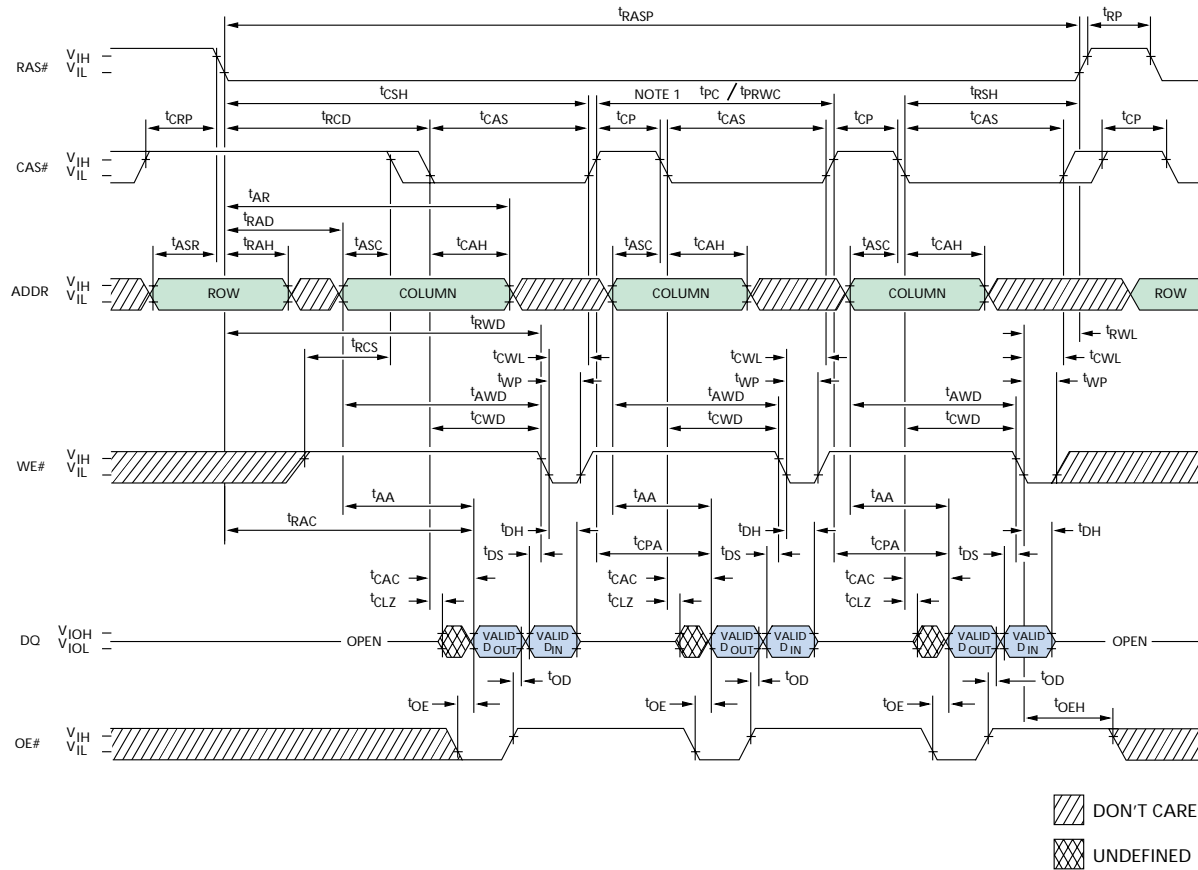


## TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
<sup>t</sup> AR	40		45		ns
<sup>t</sup> ASC	0		0		ns
<sup>t</sup> ASR	0		0		ns
<sup>t</sup> CAH	8		10		ns
<sup>t</sup> CAS	13	10,000	15	10,000	ns
<sup>t</sup> CP	8		10		ns
<sup>t</sup> CRP	5		5		ns
<sup>t</sup> CSH	50		60		ns
<sup>t</sup> CWL	13		15		ns
<sup>t</sup> DH	8		10		ns
<sup>t</sup> DS	0		0		ns
<sup>t</sup> PC	30		35		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
<sup>t</sup> RAD	13		15		ns
<sup>t</sup> RAH	8		10		ns
<sup>t</sup> RASP	50	125,000	60	125,000	ns
<sup>t</sup> RCD	18		20		ns
<sup>t</sup> RP	30		40		ns
<sup>t</sup> RSH	13		15		ns
<sup>t</sup> RWL	13		15		ns
<sup>t</sup> WCH	8		10		ns
<sup>t</sup> WCR	40		45		ns
<sup>t</sup> WCS	0		0		ns
<sup>t</sup> WP	8		10		ns

## FAST-PAGE-MODE READ-WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE cycles)



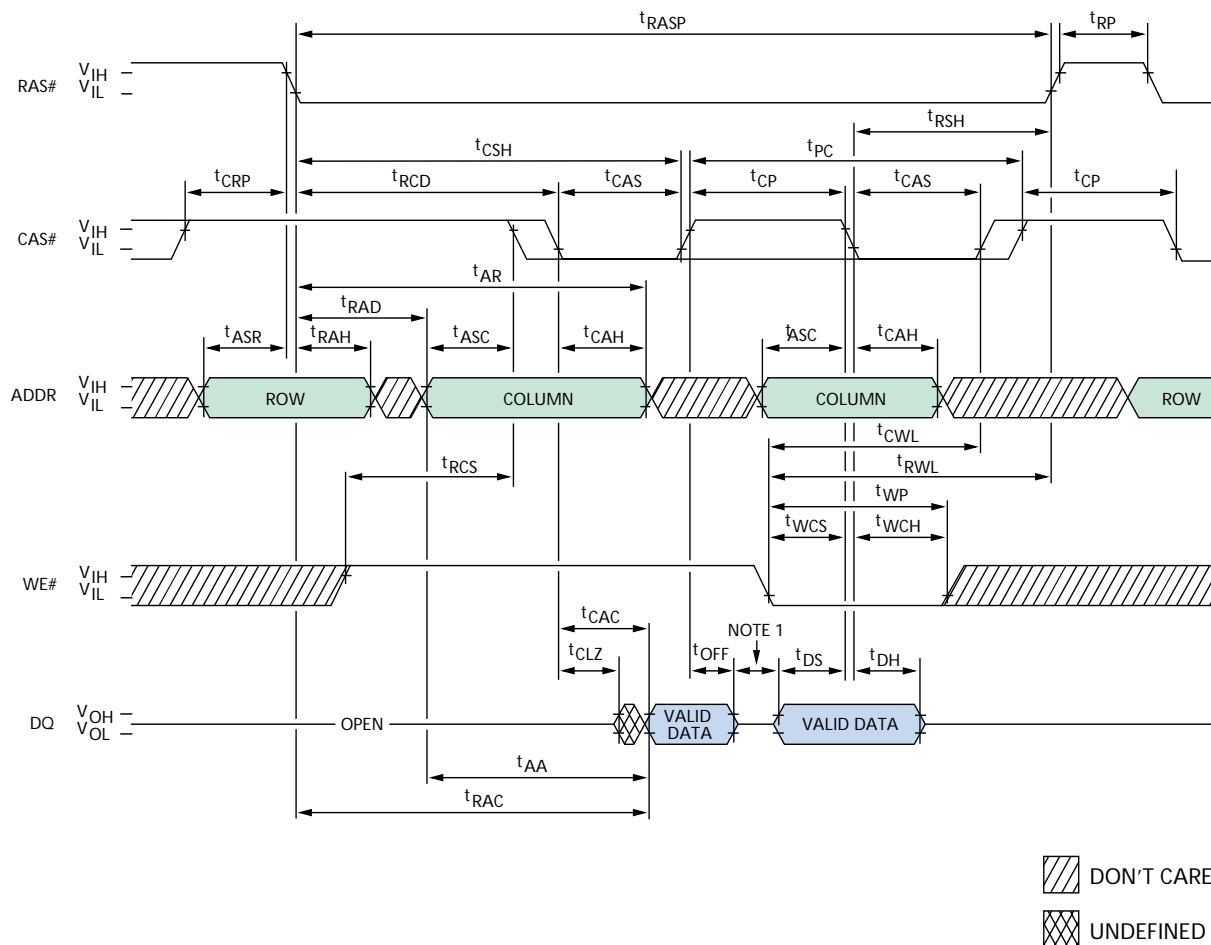
### TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{AA}$		25		30	ns
$t_{AR}$	40		45		ns
$t_{ASC}$	0		0		ns
$t_{ASR}$	0		0		ns
$t_{AWD}$	48		55		ns
$t_{CAC}$		13		15	ns
$t_{CAH}$	8		10		ns
$t_{CAS}$	13	10,000	15	10,000	ns
$t_{CLZ}$	3		3		ns
$t_{CP}$	8		10		ns
$t_{CPA}$		30		35	ns
$t_{CRP}$	5		5		ns
$t_{CSH}$	50		60		ns
$t_{CWD}$	36		40		ns
$t_{CWL}$	13		15		ns
$t_{DH}$	8		10		ns
$t_{DS}$	0		0		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{OD}$	3	13	3	15	ns
$t_{OE}$		13		15	ns
$t_{OEHL}$	13		15		ns
$t_{PC}$	30		35		ns
$t_{PRWC}$	76		85		ns
$t_{RAC}$		50		60	ns
$t_{RAD}$	13		15		ns
$t_{RAH}$	8		10		ns
$t_{RASP}$	50	125,000	60	125,000	ns
$t_{RCD}$	18		20		ns
$t_{RCS}$	0		0		ns
$t_{RP}$	30		40		ns
$t_{RSH}$	13		15		ns
$t_{RWD}$	73		85		ns
$t_{RWL}$	13		15		ns
$t_{WP}$	8		10		ns

**NOTE:** 1.  $t_{PC}$  is for LATE WRITE only.

## FAST-PAGE-MODE READ EARLY WRITE CYCLE (Pseudo READ-MODIFY-WRITE)



### TIMING PARAMETERS

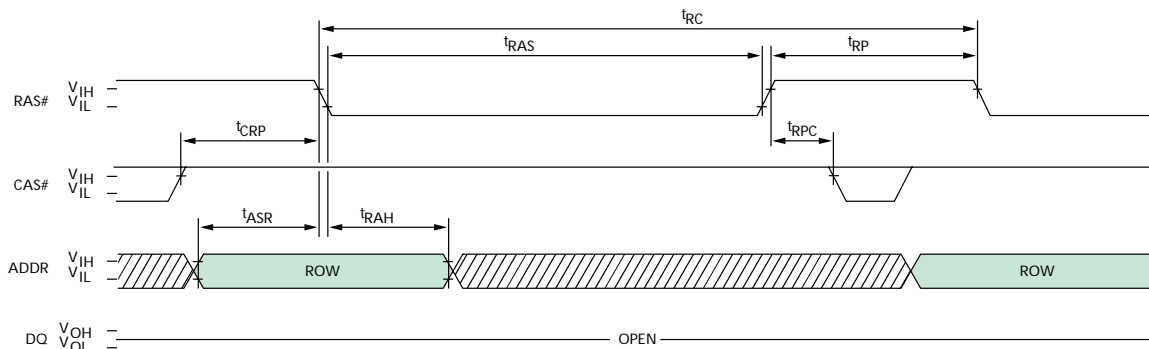
SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>AA</sub>		25		30	ns
t <sub>AR</sub>	40		45		ns
t <sub>ASC</sub>	0		0		ns
t <sub>ASR</sub>	0		0		ns
t <sub>CAC</sub>		13		15	ns
t <sub>CAH</sub>	8		10		ns
t <sub>CAS</sub>	13	10,000	15	10,000	ns
t <sub>CLZ</sub>	3		3		ns
t <sub>CP</sub>	8		10		ns
t <sub>CRP</sub>	5		5		ns
t <sub>CSH</sub>	50		60		ns
t <sub>CWL</sub>	13		15		ns
t <sub>DH</sub>	8		10		ns
t <sub>DS</sub>	0		0		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>OFF</sub>	3	13	3	15	ns
t <sub>PC</sub>	30		35		ns
t <sub>RAC</sub>		50		60	ns
t <sub>RAD</sub>	13		15		ns
t <sub>RAH</sub>	8		10		ns
t <sub>RASP</sub>	50	125,000	60	125,000	ns
t <sub>RCD</sub>	18		20		ns
t <sub>RCS</sub>	0		0		ns
t <sub>RP</sub>	30		40		ns
t <sub>RSH</sub>	13		15		ns
t <sub>RWL</sub>	13		15		ns
t <sub>WCH</sub>	8		10		ns
t <sub>WCS</sub>	0		0		ns
t <sub>WP</sub>	8		10		ns

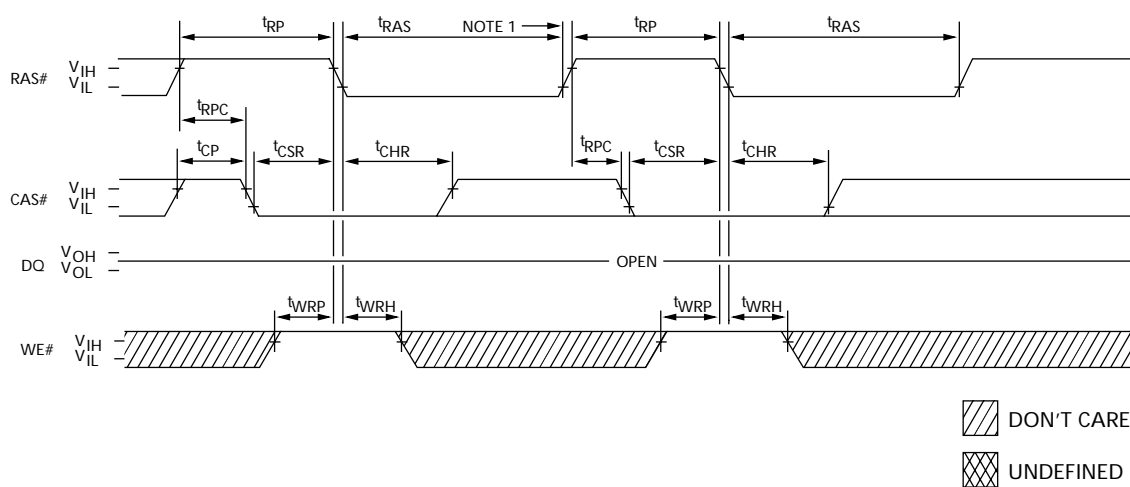
**NOTE:** 1. Do not drive input data prior to output data going High-Z.



### RAS#-ONLY REFRESH CYCLE (OE# and WE# = DON'T CARE)



### CBR REFRESH CYCLE (Addresses and OE# = DON'T CARE)



### TIMING PARAMETERS

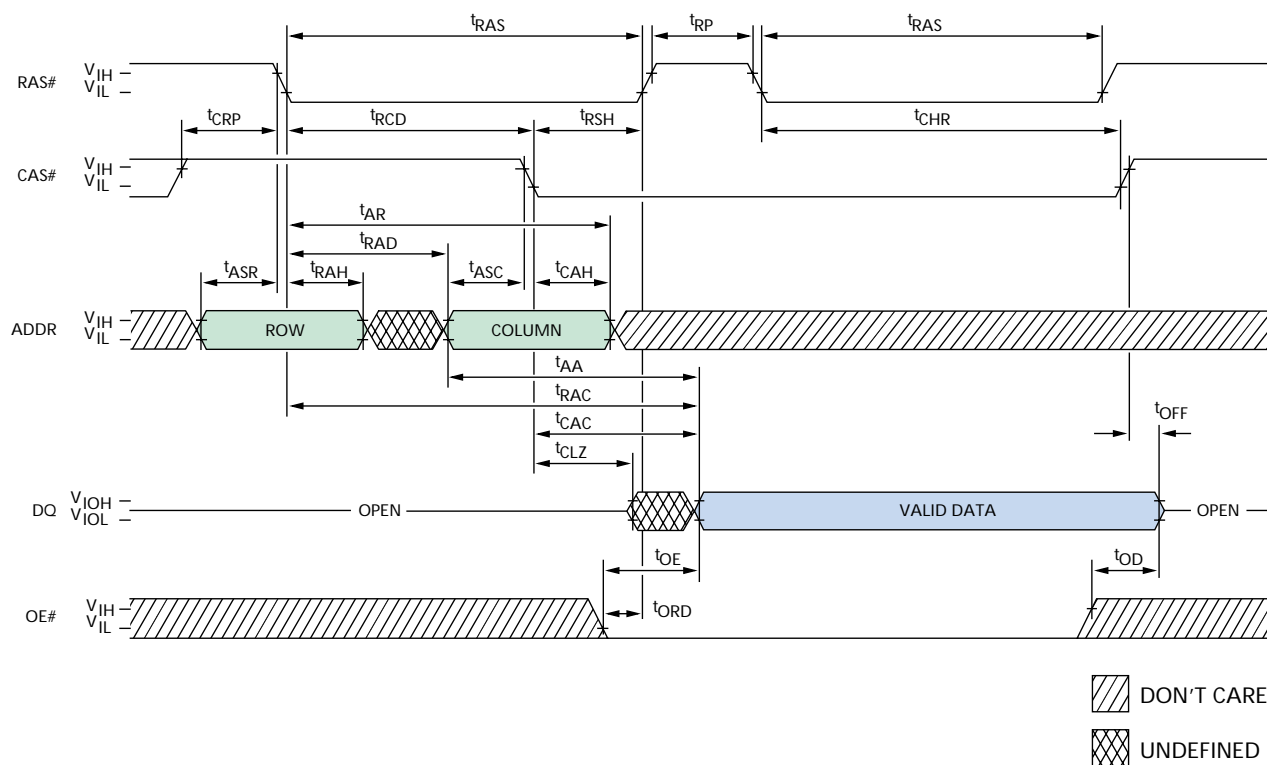
SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{AS}$	0		0		ns
$t_{CHR}$	15		15		ns
$t_{CP}$	8		10		ns
$t_{CRP}$	5		5		ns
$t_{CSR}$	5		5		ns
$t_{RAH}$	8		10		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{RAS}$	50	10,000	60	10,000	ns
$t_{RC}$	90		110		ns
$t_{RP}$	30		40		ns
$t_{RPC}$	0		0		ns
$t_{WRH}$	10		10		ns
$t_{WRP}$	10		10		ns

**NOTE:** 1. End of CBR REFRESH cycle.

## HIDDEN REFRESH CYCLE <sup>1</sup>

(WE# = HIGH; OE# = LOW)



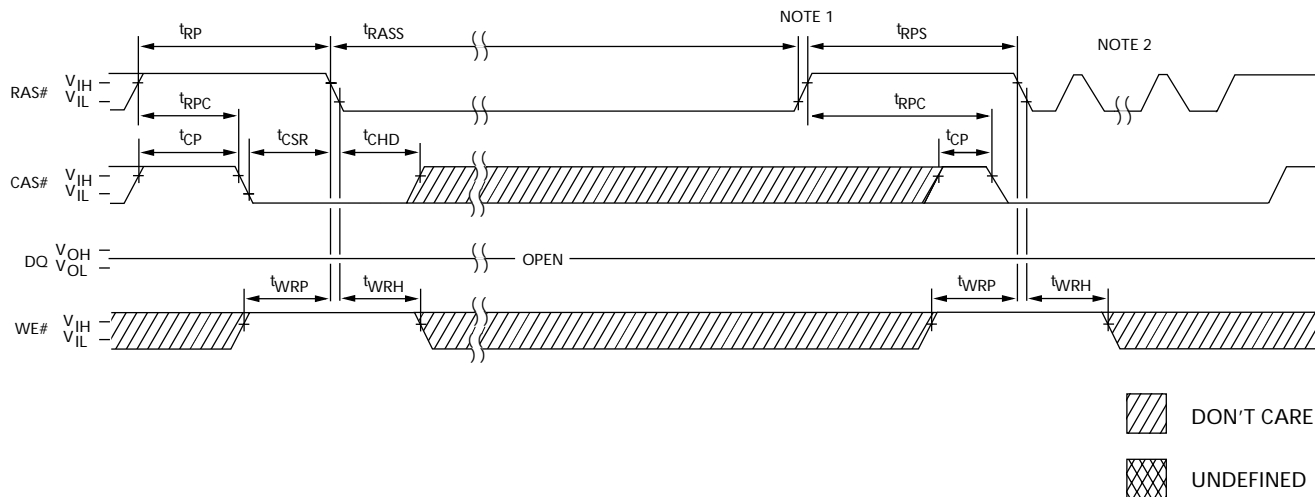
### TIMING PARAMETERS

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>AA</sub>		25		30	ns
t <sub>AR</sub>	40		45		ns
t <sub>ASC</sub>	0		0		ns
t <sub>ASR</sub>	0		0		ns
t <sub>CAC</sub>		13		15	ns
t <sub>CAH</sub>	8		10		ns
t <sub>CHR</sub>	15		15		ns
t <sub>CLZ</sub>	3		3		ns
t <sub>CRP</sub>	5		5		ns
t <sub>OD</sub>	3	13	3	15	ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
t <sub>OE</sub>		13		15	ns
t <sub>OFF</sub>	3	13	3	15	ns
t <sub>ORD</sub>	0		0		ns
t <sub>RAC</sub>		50		60	ns
t <sub>RAD</sub>	13		15		ns
t <sub>RAH</sub>	8		10		ns
t <sub>RAS</sub>	50	10,000	60	10,000	ns
t <sub>RCD</sub>	18		20		ns
t <sub>RP</sub>	30		40		ns
t <sub>RSH</sub>	13		15		ns

**NOTE:** 1. A HIDDEN REFRESH may also be performed after a WRITE cycle. In this case, WE# is LOW and OE# is HIGH.

## SELF REFRESH CYCLE (Addresses and OE# = DON'T CARE)

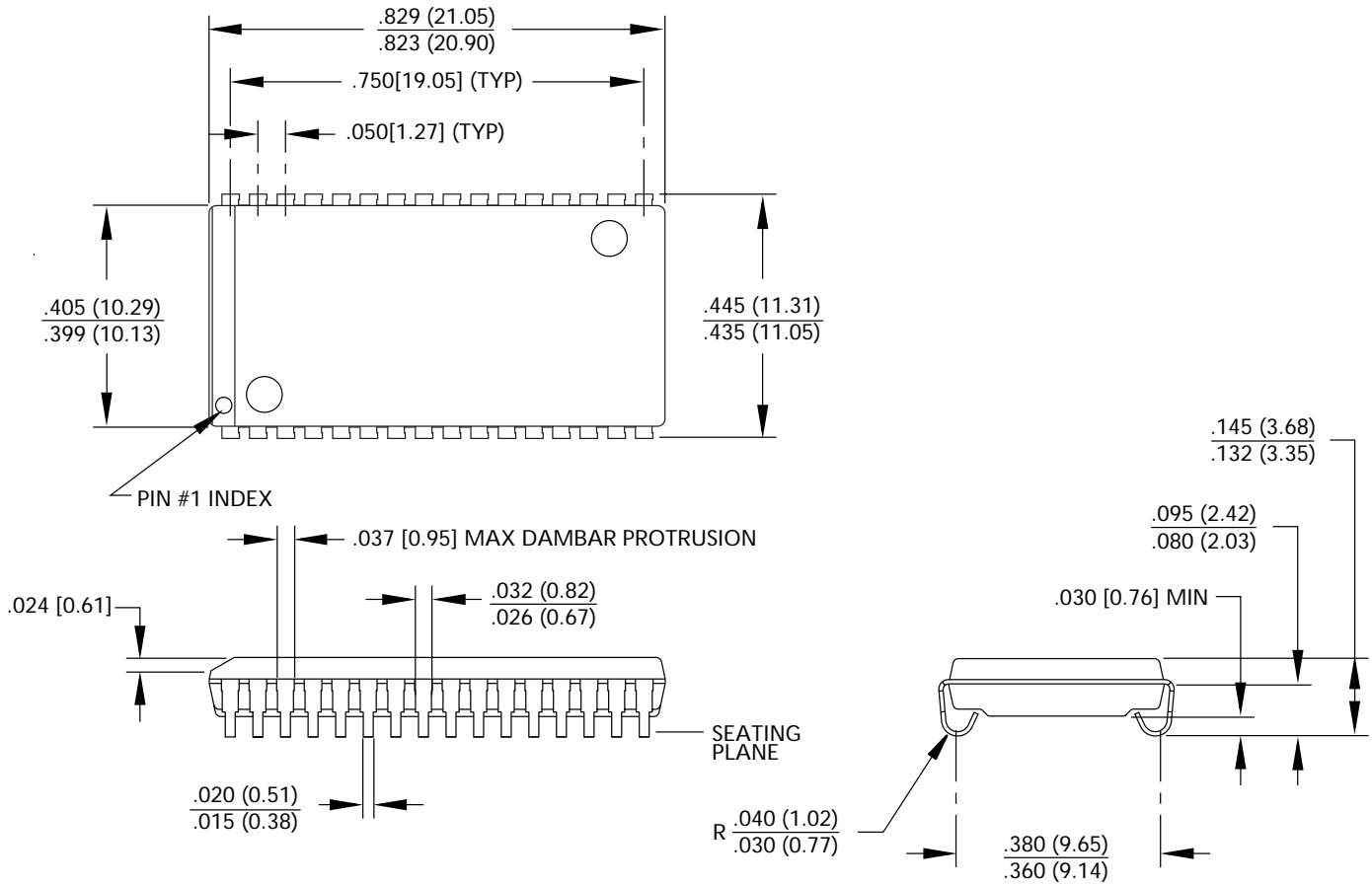


### TIMING PARAMETERS

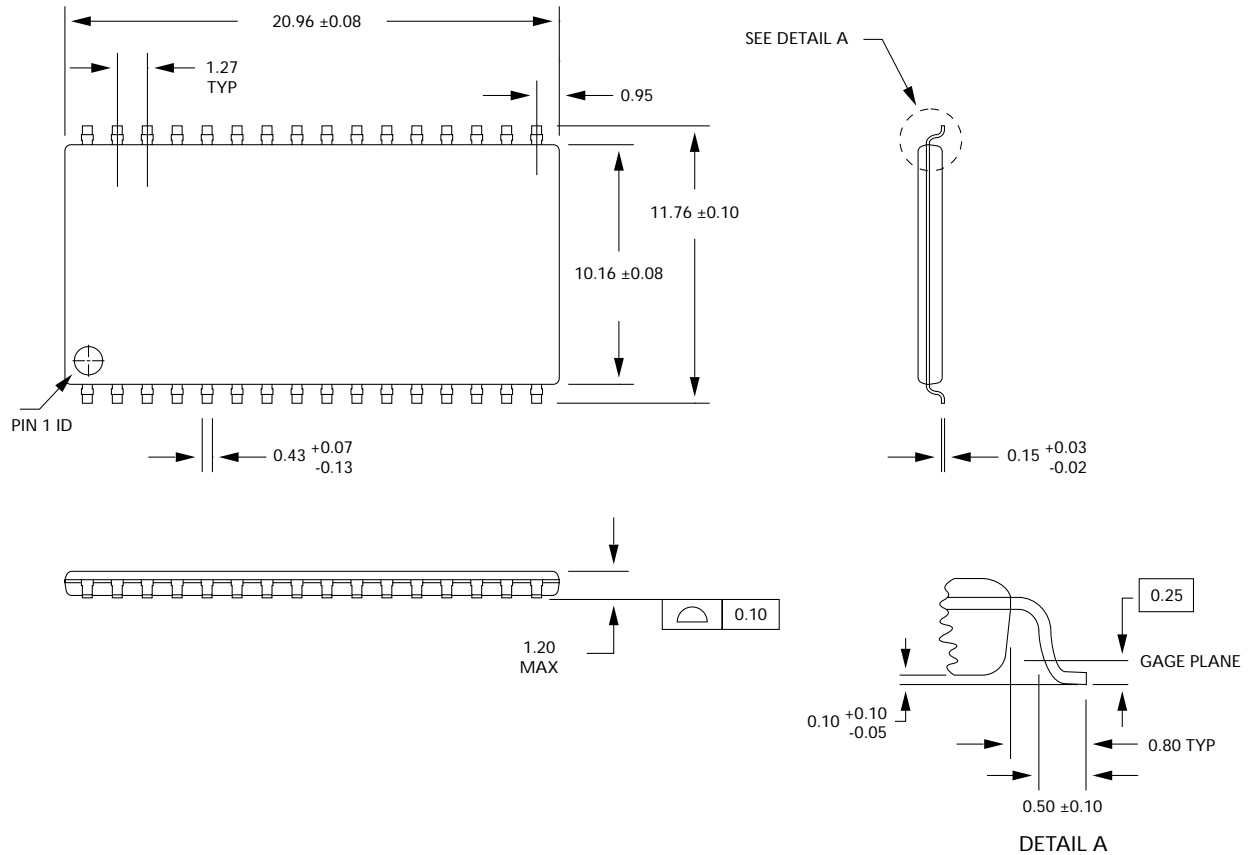
SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{CHD}$	15		15		ns
$t_{CP}$	8		10		ns
$t_{CSR}$	5		5		ns
$t_{RASS}$	100		100		$\mu$ s
$t_{RP}$	30		40		ns

SYMBOL	-5		-6		UNITS
	MIN	MAX	MIN	MAX	
$t_{RPC}$	0		0		ns
$t_{RPS}$	90		105		ns
$t_{WRH}$	10		10		ns
$t_{WRP}$	10		10		ns

**NOTE:** 1. Once  $t_{RASS}$  (MIN) is met and RAS# remains LOW, the DRAM will enter self refresh mode.  
 2. Once  $t_{RPS}$  is satisfied, a complete burst of all rows should be executed, if RAS#-only or burst CBR refresh is used.

**32-PIN PLASTIC SOJ (400 mil)**


- NOTE:** 1. All dimensions in inches (millimeters)  $\frac{\text{MAX}}{\text{MIN}}$  or typical where noted.
2. Package width and length do not include mold protrusion; allowable mold protrusion is .01" per side.

**32-PIN PLASTIC TSOP (400 mil)**


- NOTE:** 1. All dimensions in millimeters  $\frac{\text{MAX}}{\text{MIN}}$  or typical where noted.
2. Package width and length do not include mold protrusion; allowable mold protrusion is .25mm per side.



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